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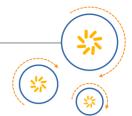






## RF360 Europe GmbH

## A Qualcomm - TDK Joint Venture



## **SAW Components**

## **SAW Duplexer**

WCDMA/LTE Band IX

Series/type: B8557

Ordering code: B39182B8557P810

Date: July 21, 2011

Version: 2.0

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## **SAW Components**

SAW Duplexer WCDMA/LTE Band IX

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SAW Components

B8557

**SAW Duplexer** 

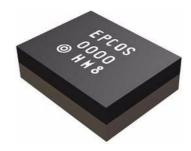
1767.4 / 1862.4 MHz

**Data Sheet** 



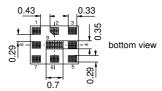
### **Application**

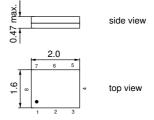
- Low-loss SAW duplexer for mobile telephone WCDMA/LTE Band IX systems
- Low insertion attenuation
- Low amplitude ripple
- Usable passband 35 MHz
- Single ended to balanced transformation in Antenna Rx path
- Impedance transformation 50Ω to 100Ω in Antenna Rx path



#### **Features**

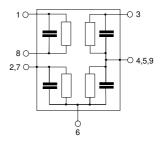
- Package size 2.0 \* 1.6 mm²
- Max. height 0.47 mm
- RoHS compatible
- Approximate weight 0.006g
- Package for Surface Mount Technology (SMT)
- Ni terminals, Au-plated
- Balanced Rx port, unbalanced Tx port
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level (MSL) 3





#### Pin configuration

- 3 TX Input
- 1,8 RX Output (balanced)
- 6 Antenna
- 2, 4, 5 To be grounded
- 7,9 To be grounded





SAW Components B8557

**SAW Duplexer** 1767.4 / 1862.4 MHz

**Data Sheet**  $\equiv$ MD

Characteristics

Temperature range for specification:  $T = -30^{\circ}C \text{ to } +85^{\circ}C$  $Z_{ANT} = 50 \Omega \parallel 3.6 \text{ nH}$ Antenna terminating impedance:

 $Z_{RX} = 100 \Omega$  (balanced) || 8.2 nH  $Z_{TX} = 50 \Omega$ RX terminating impedance:

TX terminating impedance:

Characterisitcs TX - ANT			min.	typ.	max.	
				@ 25 °C		
Center frequency		f <sub>C</sub>	_	1767.4	_	MHz
Maximum insertion attenuation						
1749.9 1784.9	MHz			1.4	1.8	dB
@f <sub>carrier</sub> 1752.4 1782.4	MHz	$\alpha_{WCDMA}^{1)}$		1.4	1.8	dB
Amplitude ripple(p-p)						
1749.9 1784.9	MHz			0.4	0.8	dB
@f <sub>carrier</sub> 1752.4 1782.4	MHz	$\alpha_{\text{WCDMA}^{3)}}$		0.4	0.8	dB
Error Vector Magnitude						
@f <sub>carrier</sub> 1752.4 1782.4	MHz	EVM <sup>2)</sup>		1.3	2.0	%
Input VSWR (TX port)						
1749.9 1784.9	MHz			1.4	1.8	
Output VSWR (ANT port)						
1749.9 1784.9	MHz			1.5	1.8	

<sup>1)</sup> Attenuation of WCDMA signal ("Powertransferfunction"). Please refer to annotation on page (8).

<sup>2)</sup> Error Vector Magnitude (EVM) based on definition given in 3GPP TS 25.141.



SAW Components B8557

**SAW Duplexer** 1767.4 / 1862.4 MHz

**Data Sheet**  $\equiv$ MD

#### Characteristics

Temperature range for specification:  $T = -30^{\circ}C \text{ to } +85^{\circ}C$ Antenna terminating impedance:  $Z_{ANT}=$ 50 Ω || 3.6 nH

 $Z_{RX} = 100 \Omega$  (balanced) || 8.2 nH RX terminating impedance:

Z<sub>TX</sub> = TX terminating impedance:  $50 \Omega$ 

Characterisitcs TX - ANT			min.	typ.	max.	
				@ 25 °C		
Attenuation		α				
10.0 95.0	MHz		30	80		dB
470.0 770.0	MHz		30	48		dB
810.0 828.0	MHz		30	47		dB
860.0 895.0	MHz		30	46		dB
921.0 960.0	MHz		30	45		dB
1475.9 1500.9	MHz		30	40		dB
1500.9 1565.42	MHz		30	40		dB
1565.42 1573.374	- MHz		40	43		dB
1573.374 1577.466	MHz		40	43		dB
1577.466 1585.42	MHz		40	44		dB
1597.5515 1605.886	MHz		40	46		dB
1605.886 1680.0	MHz		25	31		dB
1805.0 1845.0	MHz		1	4		dB
1844.9 1879.9	MHz		45	50		dB
@f <sub>carrier</sub> 1847.4 1877.4	MHz	$\alpha_{WCDMA}^{1)}$	45	50		dB
1884.5 1919.6	MHz		40	46		dB
2110.0 2170.0	MHz		27	42		dB
2400.0 2500.0	MHz		35	40		dB
3500.0 3570.0	MHz		20	31		dB
5150.0 5355.0	MHz		20	23		dB
5725.0 5850.0	MHz		18	21		dB

<sup>1)</sup> Attenuation of WCDMA signal ("Powertransferfunction"). Please refer to annotation on page (8).



SAW Components B8557

SAW Duplexer 1767.4 / 1862.4 MHz

Data Sheet

#### Characteristics

Temperature range for specification: T = -30 °C to +85 °C Antenna terminating impedance:  $Z_{\Delta NT} = 50 \Omega \parallel 3.6 \text{ nH}$ 

RX terminating impedance:  $Z_{RX} = 100 \Omega$  (balanced) || 8.2 nH

TX terminating impedance:  $Z_{TX} = 50 \Omega$ 

Characterisitcs ANT - RX	min.	typ.	max.		
		@ 25 °C			
Center frequency f <sub>C</sub>	_	1862.4	_	MHz	
Maximum insertion attenuation					
1844.9 1879.9 MHz		2.0	2.5	dB	
@f $_{\text{carrier}}$ 1847.4 1877.4 MHz $_{\alpha_{\text{WCDMA}}}$	(1)	2.0	2.5	dB	
Amplitude ripple(p-p)					
1844.9 1879.9 MHz		0.4	0.7	dB	
@f <sub>carrier</sub> 1847.4 1877.4 MHz $\alpha_{WCDMA}$	(3)	0.3	0.7	dB	
Common Mode Rejection Ratio CMRR					
1844.9 1879.9 MHz	212)	26		dB	
Input VSWR (ANT port)					
1844.9 1879.9 MHz		1.4	1.8		
Output VSWR (RX port)					
1844.9 1879.9 MHz		1.4	1.8		

<sup>1)</sup> Attenuation of WCDMA signal ("Powertransferfunction"). Please refer to annotation on page (8).

<sup>2)</sup> A combination of 10° phase balance and 1dB amplitude balance corresponds to 19.6 dB CMRR.



SAW Components B8557

SAW Duplexer 1767.4 / 1862.4 MHz

Data Sheet = M =

#### Characteristics

Temperature range for specification:  $T = -30 \,^{\circ}\text{C}$  to +85  $^{\circ}\text{C}$  Antenna terminating impedance:  $Z_{\Delta NT} = 50 \,\Omega \parallel 3.6 \,\text{nH}$ 

RX terminating impedance:  $Z_{RX} = 100 \Omega$  (balanced) || 8.2 nH

TX terminating impedance:  $Z_{TX} = 50 \Omega$ 

Characterisitcs ANT - RX		min.	tvn	max.	_
Characteristics Airi - IIX			typ. @ 25 °C	max.	
Attenuation $\alpha$			@ <b>2</b> 3 <b>0</b>		-
10.0 95.0 MHz		70	79		dB
614.9 626.7 MHz		45	80		dB
922.5 940.0 MHz		45	72		dB
1654.9 1689.9 MHz		35	60		dB
1689.9 1750.0 MHz		35	56		dB
1749.9 1784.9 MHz		48	58		dB
@f <sub>carrier</sub> 1752.4 1782.4 MHz $\alpha_{V}$	1)	48	58		dB
1965.0 2400.0 MHz	WCDMA /	15	52		dB
2400.0 2497.0 MHz		30	52 57		dB
3594.8 3664.8 MHz		40	57 59		dВ
		-			1 -
3689.8 3759.8 MHz		35	58		dB
5344.7 5449.7 MHz		40	51		dB
5534.7 5639.7 MHz		35	51		dB
5639.7 5650.0 MHz		35	51		dB
IMD Product Level Limits <sup>2)</sup>					
at f <sub>TX</sub> = 1767.4 MHz f <sub>BX</sub> = 1862.4 MHz					
Blocker 1 95.0 MHz			-130	-105	dBm
Blocker 2 1672.4 MHz			-130	-105	dBm
					1 -
Blocker 3 3629.8 MHz			-120	-105	dBm
Blocker 4 5397.2 MHz			-124	-105	dBm

<sup>1)</sup> Attenuation of WCDMA signal ("Powertransferfunction"). Please refer to annotation on page (8).

<sup>2)</sup> IMD product level limits for power levels PTx=21.5dB (antenna port output power) and PBLOCK-ER=-15dBm (antenna port input power).



SAW Components B8557

SAW Duplexer 1767.4 / 1862.4 MHz

Data Sheet

Characteristics

Temperature range for specification: T = -30 °C to +85 °C Antenna terminating impedance:  $Z_{ANT} = 50 \Omega \parallel 3.6 \text{ nH}$ 

RX terminating impedance:  $Z_{RX} = 100 \Omega$  (balanced) || 8.2 nH

TX terminating impedance:  $Z_{TX} = 50 \Omega$ 

Characterisitcs TX - RX		min.	typ.	max.	
			@ 25 °C		
Differential Mode Isolation	α				
1749.9 1784.9	MHz	55	58		dB
@f <sub>carrier</sub> 1752.4 1782.4	MHz $\alpha_{WCDMA}^{1)}$	55	58		dB
1844.9 1879.9	MHz	50	56		dB
@f <sub>carrier</sub> 1847.4 1877.4	MHz $\alpha_{WCDMA}^{(3)}$	50	57		dB
Common mode Isolation	α				
1749.9 1784.9	MHz	53	56		dB
@f <sub>carrier</sub> 1752.4 1782.4	MHz $\alpha_{WCDMA^{3)}}$	53	56		dB

<sup>1)</sup> Attenuation of WCDMA signal ("Powertransferfunction"). Please refer to annotation on page (8).



SAW Components				B8557
SAW Duplexer				1767.4 / 1862.4 MHz
Data Sheet		=ME	2	
Maximum ratings				
Storage temperature range	T <sub>stg</sub>	-40/+85	°C	
DC voltage	$V_{DC}$	5	V	
ESD voltage	$V_{ESD}$	50 <sup>1)</sup>	V	machine model, 10 pulses
Input power at	$P_{IN}$			source and load impedance 50 $\Omega$
1749.9 1784.9 MHz elsewhere		29 10	dBm dBm	$ \begin{cases} continuous wave \\ T = 50^{\circ}C, 5.000 \text{ h} \end{cases} $

<sup>1)</sup> acc. to JESD22-A115A (machine model), 10 negative & 10 positive pulses.

#### Annotation for characteristics section

Attenuation of WCDMA signal ("Powertransferfunction",  $\alpha_{\text{WCDMA}}$ ) is determined by  $\int_{\infty}^{\infty} \left|S_{ds21}(f)H_{RRC}(f-f_{Carrier})\right|^2 df$ 

 $f_{Carrier}$  according to 3GPP TS 25.101 (e.g. for WCDMA Band 9-Passband,  $f_{Carrier}$  ranges from 1752.4 MHz (lowest Tx channel) to 1782.4 MHz (highest Tx channel)).  $H_{RRC}(f)$  is the transfer function of the root-raised cosine transmit pulse shaping filter according to 3GPP TS 25.101 with the following normalization:

$$\int_{-\infty}^{\infty} \left| H_{RRC}(f) \right|^2 df = 1$$

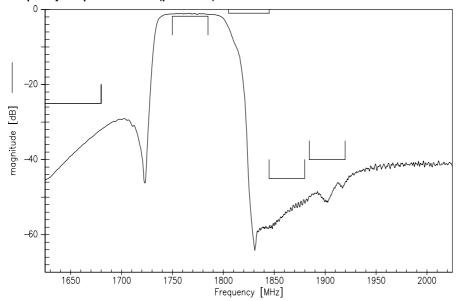


SAW Components B8557 SAW Duplexer 1767.4 / 1862.4 MHz

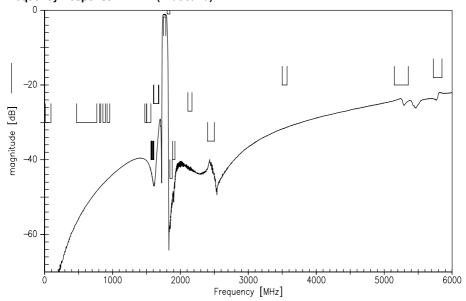
**Data Sheet** 



## Frequency Response Tx-ANT (passband)



## Frequency Response Tx-ANT (wideband)



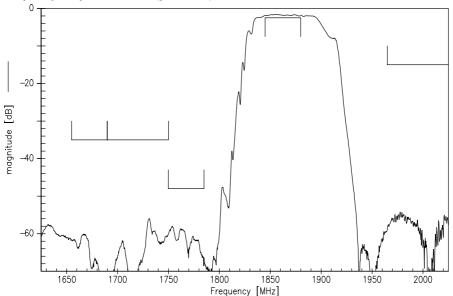


SAW Components B8557 SAW Duplexer 1767.4 / 1862.4 MHz

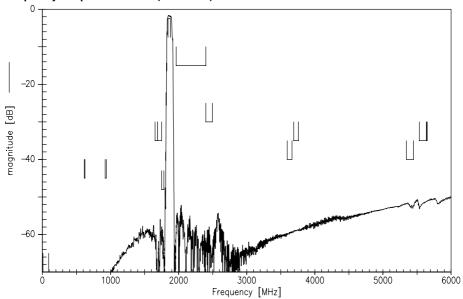
**Data Sheet** 



## Frequency Response ANT-Rx (passband)



## Frequency Response ANT-Rx (wideband)



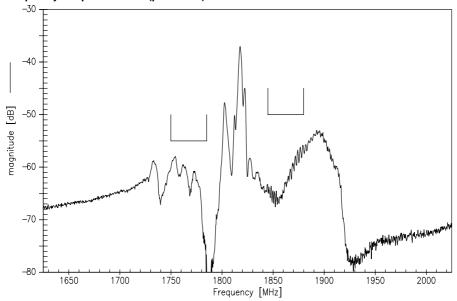


SAW Components B8557 **SAW Duplexer** 1767.4 / 1862.4 MHz

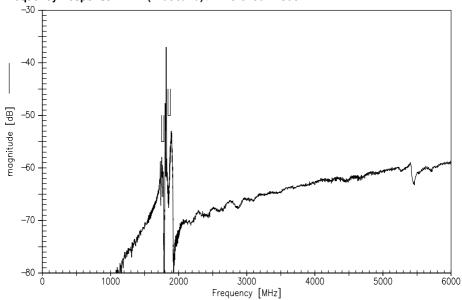
**Data Sheet** 



## Frequency Response Tx-Rx (passband) / Differential Mode



## Frequency Response Tx-Rx (wideband) / Differential Mode





1767.4 / 1862.4 MHz

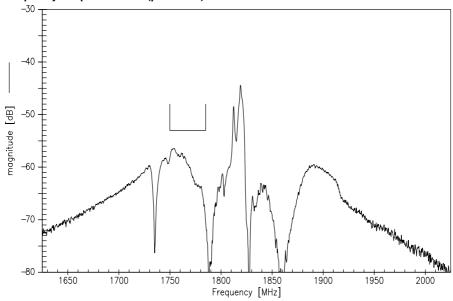
SAW Components B8557

**Data Sheet** 

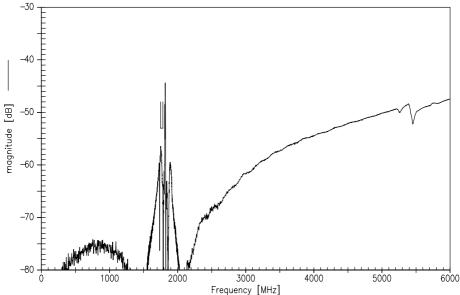
**SAW Duplexer** 



### Frequency Response Tx-Rx (passband) / Common Mode



## Frequency Response Tx-Rx (wideband) / Common Mode





SAW Components B8557 **SAW Duplexer** 1767.4 / 1862.4 MHz **Data Sheet** Return Loss  $S_{11}$  Tx - port  $S_{22}$  ANT - port  $S_{33}$  Rx - port  $|S_{11}|$  $\Box = 1749.9$ O = 1784.9  $\Box = 1844.9$ O = 1879.93 VSWR 2 1750 1800 1850 1900 normal impedance: 50.00 ∩ frequency [MHz]  $|S_{33}|$  $\Box$  = 1749.9  $\bigcirc$  = 1784.9  $\Box$  = 1844.9  $\bigcirc$  = 1879.9 VSWR 1750 1800 1850 1900 normal impedance: 50.00 ∩ frequency [MHz]  $|S_{22}|$  $\Box = 1749.9$ O = 1784.9 □ = 1844.9 O = 1879.93 VSWR 2 1750 1800 1850 1900 normal impedance: 50.00 ∩ frequency [MHz]



SAW Components	B8557
SAW Duplexer	1767.4 / 1862.4 MHz
Data Sheet	=MD

#### References

Туре	B8557
Ordering code	B39182B8557P810
Marking and package	C61157-A8-A38
Packaging	F61074-V8247-Z000
Date codes	L_1126
S-parameters	B8557_NB.s4p, B8557_WB.s4p See file header for port/pin assignment table.
Soldering profile	S_6001
RoHS compatible	defined as compatible with the following documents: "DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment. 2005/618/EC from April 18th, 2005, amending Directive 2002/95/EC of the European Parliament and of the Council for the purposes of establishing the maxi- mum concentration values for certain hazardous substances in electrical and electronic equipment."
Moldability	Before using in overmolding environment, please contact your EPCOS sales office.
Matching coils	See Inductor pdf-catalog     http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation     http://www.tdk.co.jp/etvcl/index.htm

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